

Reflow connectors

Electronics | Connectors

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Benefits

- Cost-effective
- High flowability
- Enable thin—wall designs
- Low moisture absorption
- Flame retardant



Details

Stanyl® PA46 and ForTii® PA4T are reliable solutions for reflow connectors due to their high melting temperatures (allowing the use of high reflow temperatures) and high mechanical performance (implying a reduced reject rate during pin assembly, plus meeting mechanical specification also after reflow soldering). For Tii PA4T increases the reliability even due to a high dimensional stability, a low and isotropic CLTE leading to high co-planarity and low warpage after soldering.

Products

Stanul® TS250F8

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